

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of
KANAYAMA et al.

Serial No. 10/522,725

Filed: September 22, 2005



Atty. Ref.: ARC-1417-495

TC/A.U.: 1796

Examiner: Frank

For: LOW-HEAT ACCUMULATING THERMOPLASTIC RESIN
COMPOSITION AND MOLDED PRODUCT

* * * * *

August 19, 2008

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

Applicants bring to the attention of the Patent and Trademark Office JP-A-2001-164082 (with English abstract) and JP-A-2002-69326 (patent family member is U.S. 6,485,557) cited during the examination of the underlying Japanese application. All three documents are listed on the attached form PTO/SB/08a. Copies of the JP documents (and abstract) are attached.

The Examiner is requested to initial the attached form PTO/SB/08a and to return a copy of the initialed document to the undersigned as an indication that the listed documents have been considered and made of record.


The relevant fee of \$180.00 to assure consideration of this paper is submitted herewith. You are hereby authorized to charge any further expense in connection with this Submission to our deposit account No. 14-1140 for any fees required in connection with the filing of this paper.

KANAYAMA et al.
Serial No. 10/522,725

Respectfully submitted,

NIXON & VANDERHYE P.C.

By: _____


Arthur R. Crawford
Reg. No. 25,327

ARC:eaw
901 North Glebe Road, 11th Floor
Arlington, VA 22203-1808
Telephone: (703) 816-4000
Facsimile: (703) 816-4100